

- Ideal Front-End Filter for European Wireless Receivers
- Low-Loss, Coupled-Resonator Quartz Design
- Simple External Impedance Matching
- Complies with Directive 2002/95/EC (RoHS)

The RF3701E is a low-loss, compact, and economical surface-acoustic-wave (SAW) filter designed to provide front-end RF selectivity in 433.92 MHz receivers. Receiver designs using this filter include superheterodyne with 10.7 MHz or lower intermediate frequencies, plus direct conversion and superregeneratives.

# **RF3701E**

## 433.92 MHz SAW Filter



### **Electrical Characteristics**

Characteristic		Sym	Notes	Minimum	Typical	Maximum	Units
Center Frequency @ 25°C		f <sub>C</sub>	1, 2, 3		433.92		MHz
Insertion Loss		IL <sub>MIN</sub>	1, 3		2.5	3.2	dB
3 dB Bandwidth		BW3	1, 2, 3	650	750	850	kHz
Passband Ripple, 433.72 to 434.12 MHz					0.5	1.0	dB <sub>P-P</sub>
	10 to 414 MHz			44	47		dB
	414 to 424 MHz			42	45		
	424 to 431 MHz			27	30		
Attenuation relative to IL <sub>MIN</sub>	431 to 432 MHz		1.0	17	20		
	432 to 433 MHz		1,3	14	17		
	434.92 to 442 MHz			13	16		
	442 to 550 MHz			33	37		
	550 to 1000 MHz			47	50		
Temperature	Freq. Temp. Coefficient	FTC	3, 4		0.032		ppm/°C <sup>2</sup>
Frequency Aging	Absolute Value during the First Year	fA	5		<10		ppm/yr
Impedance @ f.	Input $Z_{IN} = R_{IN}    C_{IN}$	Z <sub>IN</sub>	4	3530 Ω    2.42 pF			
	Output $Z_{OUT} = R_{OUT}    C_{OUT}$	Z <sub>OUT</sub>		3330 Ω    2.42 pF			
Lid Symbolization (in addition to Lot and/or Date Codes)					940 // `	YWWS	
Standard Reel Quantity Reel Size 7 Inch			0	500 Pieces/Reel			
Reel Size 13 Inch			Э	3000 Pieces/Reel			



#### Notes:

- Unless noted otherwise, all measurements are made with the filter installed in the specified test fixture which is connected to a 50 Ω test system with VSWR ≤ 1.2:1. The test fixture L and C are adjusted for minimum insertion loss at the filter center frequency, f<sub>c</sub>. Note that insertion loss and bandwidth and passband shape are dependent on the impedance matching component values and quality.
- 2. The frequency f<sub>c</sub> is defined as the midpoint between the 3dB frequencies.
- 3. Where noted specifications apply over the entire specified operating temperature range of -40 to 90°C.
- 4. The turnover temperature,  $T_0$ , is the temperature of maximum (or turnover) frequency,  $f_0$ . The nominal frequency at any case temperature,  $T_c$ , may be calculated from:  $f = f_0 [1 - FTC (T_0 - T_c)^2]$ .
- Frequency aging is the change in fc with time and is specified at +65 °C or less. Aging may exceed the specification for prolonged temperatures above +65 °C. Typically, aging is greatest the first year after manufacture, decreasing significantly in subsequent years.
- 6. The design, manufacturing process, and specifications of this device are subject to change.
- 7. One or more of the following U.S. Patents apply: 4,54,488, 4,616,197, and others pending.
- 8. All equipment designs utilizing this product must be approved by the appropriate government agency prior to manufacture or sale.
- 9. Tape and Reel Standard for ANSI / EIA 481.

Absolute Maximum Ratings

Characteristic	Value	Units
Input Power Level	10	dBm
DC Voltage	12	VDC
Storage Temperature	-40 to +125	°C
Operable Temperature Range	-40 to +125	°C
Soldering Temperature (10 seconds / 5 cycles maximum)	260	°C

## SM3030-8 Case

### 8-Terminal Ceramic Surface-Mount Case 3.0 x 3.0 mm Nominal Footprint

### **Electrical Connections**

1Input Ground2Input3Ground4Case Ground5Output Ground6Output7Ground	Pin	Connection
2Input3Ground4Case Ground5Output Ground6Output7Ground	1	Input Ground
3Ground4Case Ground5Output Ground6Output7Ground	2	Input
4Case Ground5Output Ground6Output7Ground	3	Ground
5Output Ground6Output7Ground	4	Case Ground
6 Output 7 Ground	5	Output Ground
7 Ground	6	Output
	7	Ground
8 Case Ground	8	Case Ground

### Matching Circuit to 50 $\boldsymbol{\Omega}$





PCB Footprint Dimensions



### Case Dimensions

	mm			Inches			
Dimension	Min	Nom	Max	Min	Nom	Max	
Α	2.87	3.0	3.13	0.113	0.118	0.123	
В	2.87	3.0	3.13	0.113	0.118	0.123	
С	1.14	1.27	1.40	0.045	0.050	0.055	
D	0.79	0.92	1.05	0.031	0.036	0.041	
E	0.62	0.75	0.88	0.024	0.029	0.034	
F	0.47	0.60	0.73	0.018	0.024	0.029	
G	0.47	0.60	0.73	0.018	0.024	0.029	
Н	1.07	1.20	1.33	0.042	0.047	0.052	

### Case Materials

	Materials
Solder Pad Plating	0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel
Lid Plating	2.0 to 3.0 µm Nickel
Body	Al <sub>2</sub> O <sub>3</sub> Ceramic
Pb Free	